MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

CPGA68, 27.94x27.94
CASE 107EP
ISSUE O

DATE 30 JUL 2014

NOTES:
1. COVER GLASS IS VISUALLY ALIGNED
OVER DIE — NO GUARANTEE OF
LOCATION ACCURACY.

Dimensions in: Inches [mm]

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NOTES:
1. CENTER OF IMAGE AREA IS OFFSET FROM CENTER OF PACKAGE BY (~-0.15,0.00) mm NOMINAL.
2. DIE IS VISUALLY ALIGNED WITHIN ± 2° OF ANY PACKAGE CAVITY EDGE.

Dimensions in: Inches [mm]

See Note 1